#### 01/31/2018 504756081

### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4802809

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

### **CONVEYING PARTY DATA**

Name	Execution Date
SHIH-YEN LIN	10/18/2016
CHI-WEN LIU	11/02/2016
CHONG-RONG WU	10/18/2016
XIANG-RUI CHANG	10/18/2016

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSIN-CHU	
State/Country:	TAIWAN	
Postal Code:	300-77	
Name:	NATIONAL TAIWAN UNIVERSITY	
Street Address:	NO. 1, SEC. 4, ROOSEVELT ROAD	
City:	TAIPEI	
State/Country:	TAIWAN	
Postal Code:	10617	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15884729

#### CORRESPONDENCE DATA

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> **PATENT** REEL: 044784 FRAME: 0875

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ATTORNEY DOCKET NUMBER:	2016-0051/24061.3357US02	
NAME OF SUBMITTER:	YILUN WANG	
SIGNATURE:	/Yilun Wang/	
<b>DATE SIGNED:</b> 01/31/2018		
Total Attachments: 4		
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PATENT REEL: 044784 FRAME: 0876

Docket No.: P20160051US00/24061.3357US01 Customer No.: 000042717

#### ASSIGNMENT

WHEREAS, we,

(1)	Shih-Yen Lin	of	Hsinchu City, Taiwan, Republic of China
(2)	Chi-Wen Liu	of	Hsinchu, Taiwan, Republic of China
(3)	Chong-Rong Wu	of	New Taipei City, Taiwan, Republic of China
(4)	Xian-Rui Chang	of	Hsin-Chu, Taiwan, Republic of China

have invented certain improvements in

## SEMICONDUCTOR DEVICE WITH TRANSITION METAL DICHALOCOGENIDE HETERO-STRUCTURE

for which we have executed an application for Letters Patent of the United States of America,

of even date filed herewith; and

X filed on May 31, 2016, and assigned application number 15/169,451; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China and NATIONAL TAIWAN UNIVERSITY ("NTU"), No. 1, Sec. 4, Roosevelt Road, Taipei, 10617 Taiwan, Republic of China are desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto TSMC and NTU, its successors, legal representatives, and assigns, our right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, continuing and continuation-in-part applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to TSMC and NTU, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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Docket No.: P20160051US00/24061.3357US01

Customer No.: 000042717

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to TSMC and NTU, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid TSMC and NTU, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Shih-Yen Lin
Residence Address:	No. 149 Sheng-Li Road, Hsinchu City, Taiwan, Republic of China
Dated: 20/6 10	Inventor Signature
Inventor Name:	Chi-Wen Liu
Residence Address:	3F, No. 561, Nan-Da Road, Hsinchu, Taiwan, Republic of China
Dated:	
	Inventor Signature
Inventor Name:	Chong-Rong Wu
Residence Address:	Zhengyi North Road, Sanchong District, New Taipei City Taiwan, Republic of China
Dated: 2016 10/1	Inventor Signature
Inventor Name:	Xiang-Rui Chang
Residence Address:	No. 1, Section 4, Roosevelt Road, Taipei 10617 Taiwan, Republic of China
Dated: 2016/10/1	8 XTang - Rut Chang Inventor Signature

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Docket No.: P20160051US00/24061.3357US01 Customer No.: 000042717

#### ASSIGNMENT

WHEREAS, we.

(1)	Shih-Yen Lin	of	Hsinchu City, Taiwan, Republic of China
(2)	Chi-Wen Liu	of	Hsinchu, Taiwan, Republic of China
(3)	Chong-Rong Wu	of	New Taipei City, Taiwan, Republic of China
(4)	Xian-Rui Chang	of	Hsin-Chu, Taiwan, Republic of China

have invented certain improvements in

# SEMICONDUCTOR DEVICE WITH TRANSITION METAL DICHALOCOGENIDE HETERO-STRUCTURE

for which we have executed an application for Letters Patent of the United States of America,

of even date filed herewith; and

X filed on May 31, 2016, and assigned application number 15/169,451; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China and NATIONAL TAIWAN UNIVERSITY ("NTU"), No. 1, Sec. 4, Roosevelt Road, Taipei, 10617 Taiwan, Republic of China are desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto TSMC and NTU, its successors, legal representatives, and assigns, our right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, continuing and continuation-in-part applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to TSMC and NTU, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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Docket No.: P20160051US00/24061.3357US01 Customer No.: 000042717

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to TSMC and NTU, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid TSMC and NTU, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Shih-Yen Lin		
Residence Address:	No. 149 Sheng-Li Road, Hsinchu City, Taiwan, Republic of China		
Dated:		Inventor Signature	
Inventor Name:	Chi-Wen Liu		
Residence Address:	3F, No. 561, Nan-Da Road, Hsinchu, Taiwan, Republic of China		
Dated: Nov. 2		Chi -We - E- Inventor Signature	
Inventor Name:	Chong-Rong Wu		
Residence Address:	Zhengyi North Road, Sanchong Taiwan, Republic of China	District, New Taipei City	
Dated:		Inventor Signature	
Inventor Name:	Xian-Rui Chang		
Residence Address:	No. 1, Section 4, Roosevelt Road, Taipei 10617 Taiwan, Republic of China		
Dated:	-		
		Inventor Signature	

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RECORDED: 01/26/2018

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